

## FEATURES

- | 350W Peak Pulse Power per Line (tp=8/20μs)
- | Protects one I/O or power Line
- | Low Clamping Voltage
- | Working Voltages : 8.0V

## APPLICATIONS

- | Cell Phone Handsets and Accessories
- | Microprocessor based equipment
- | Personal Digital Assistants (PDA'S)
- | Notebooks,Desktops,and Servers
- | Portable Instrumentation
- | Peripherals
- | Pagers



SOD-323



Marking

## IEC COMPATIBILITY

- | IEC61000-4-2 (ESD) ±15kV (air), ±8kV (contact)
- | IEC61000-4-4 (EFT) 40A (5/50ns)

## APPROVALS

|             |                                    |
|-------------|------------------------------------|
| <b>RoHS</b> | Compliance with 2011/65/EU         |
| <b>HF</b>   | Compliance with IEC61249-2-21:2003 |



Schematic Symbol

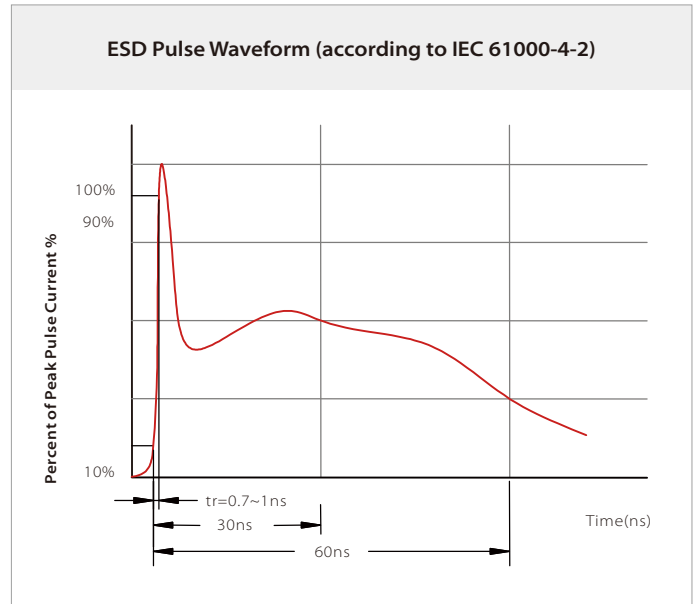
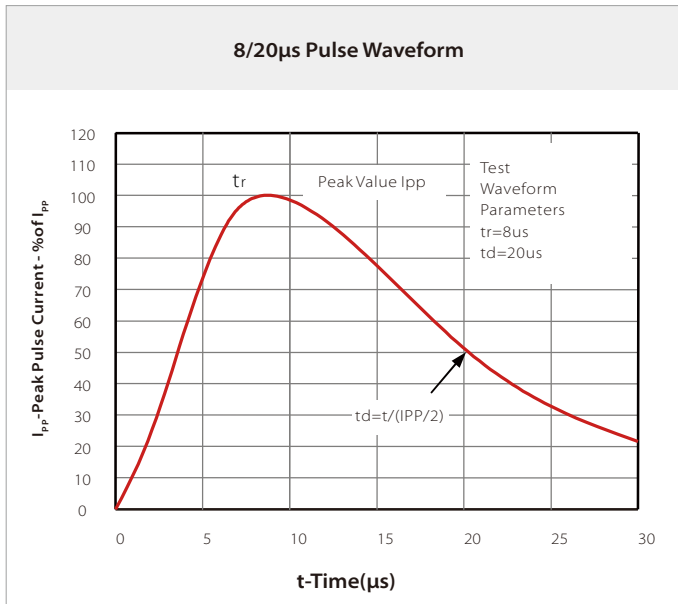
## THERMAL CONSIDERATIONS

| Symbol    | Parameter                             | Value       | Unit  |
|-----------|---------------------------------------|-------------|-------|
| $P_{PP}$  | Peak Pulse Power (tp=8/20μs waveform) | 350         | Watts |
| $T_J$     | Operating Temperature Range           | -55 to +150 | °C    |
| $T_{STG}$ | Storage Temperature Range             | -55 to +150 | °C    |

## ELECTRICAL CHARACTERISTICS

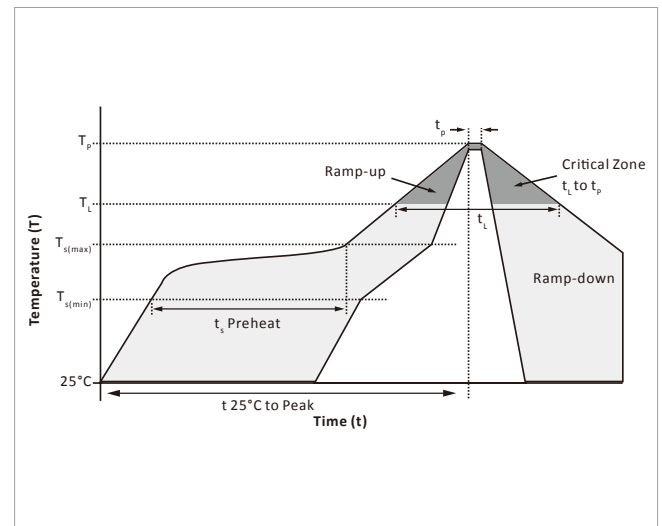
| Symbol    | Parameter                      | Condition               | Min. | Typ. | Max. | Unit |
|-----------|--------------------------------|-------------------------|------|------|------|------|
| $V_{RWM}$ | Reverse Stand-off Voltage      |                         |      |      | 8    | V    |
| $V_{BR}$  | Reverse Breakdown Voltage      | $I_T=1mA$               | 8.5  |      |      | V    |
| $I_R$     | Reverse Leakage Current        | $V_{RWM}=8V$            |      |      | 2    | μA   |
| $V_C$     | Clamping Voltage (Tp=8/20us)   | $I_{pp}=1A, tp=8/20us$  |      |      | 13.4 | V    |
| $V_C$     | Clamping Voltage (Tp=8/20us)   | $I_{pp}=15A, tp=8/20us$ |      |      | 24   | V    |
| $I_{pp}$  | Peak Pulse Current (Tp=8/20us) | tp=8/20us               |      |      | 15   | A    |
| $C_J$     | Off State Junction Capacitance | $V_R=0V, f=1MHz$        |      |      | 120  | pF   |

## CHARACTERISTIC CURVES

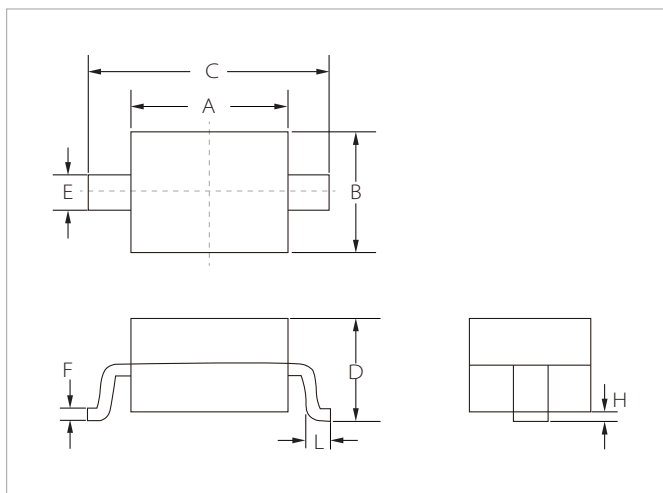


## SOLDERING PARAMETERS

| Reflow Condition                                       |                                  | Lead-free assembly |
|--------------------------------------------------------|----------------------------------|--------------------|
| Pre Heat                                               | Temperature Max ( $T_{s(min)}$ ) | 150°C              |
|                                                        | Temperature Max ( $T_{s(max)}$ ) | 200°C              |
|                                                        | Time (min to max) ( $t_s$ )      | 60 – 180 secs      |
| Average ramp up rate (Liquidus Temp ( $T_L$ ) to peak) |                                  | 3°C/second max     |
| $T_{s(max)}$ to $T_L$ - Ramp-up Rate                   |                                  | 3°C/second max     |
| Reflow                                                 | Temperature ( $T_L$ ) (Liquidus) | 217°C              |
|                                                        | Time (min to max) ( $t_L$ )      | 60 – 150 seconds   |
| Peak Temperature ( $T_p$ )                             |                                  | 260°C              |
| Time within 5°C of actual peak Temperature ( $t_p$ )   |                                  | 20 – 40 seconds    |
| Ramp-down Rate                                         |                                  | 6°C/second max     |
| Time 25°C to peak Temperature ( $T_p$ )                |                                  | 8 minutes max.     |
| Do not exceed                                          |                                  | 260°C              |

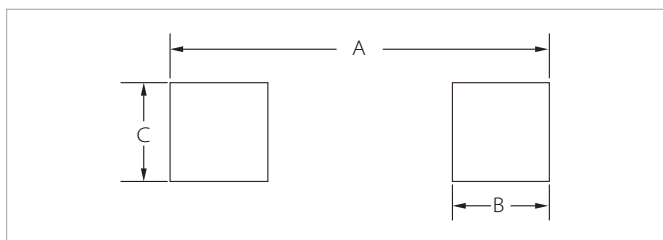


## SOD-323 PACKAGE INFORMATION



| Ref. | Millimeters |      | Inches |       |
|------|-------------|------|--------|-------|
|      | Min.        | Max. | Min.   | Max.  |
| A    | 1.60        | 1.90 | 0.063  | 0.075 |
| B    | 1.15        | 1.45 | 0.045  | 0.057 |
| C    | 2.39        | 2.75 | 0.094  | 0.108 |
| D    | 0.80        | 1.10 | 0.031  | 0.043 |
| E    | 0.25        | 0.40 | 0.010  | 0.016 |
| F    | 0.10        | 0.20 | 0.004  | 0.008 |
| H    | -           | 0.10 | -      | 0.004 |
| L    | 0.20        | 0.40 | 0.008  | 0.016 |

## RECOMMENDED PAD LAYOUT DIMENSIONS



| Ref. | Millimeters |      | Inches |       |
|------|-------------|------|--------|-------|
|      | Min.        | Max. | Min.   | Max.  |
| A    | 2.87        | 3.12 | 0.113  | 0.123 |
| B    | 0.66        | 0.91 | 0.026  | 0.036 |
| C    | 0.66        | 0.91 | 0.026  | 0.036 |

## ORDERING INFORMATION

| Part Number | Component Package | QTY/Reel | Reel Size |
|-------------|-------------------|----------|-----------|
| SESD08C     | SOD-323           | 3000PCS  | 7"        |

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